

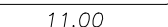
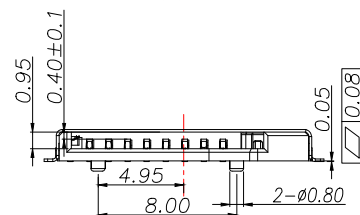


RoHS
Compliant
2011/65/EU



Compliant
Halogen Free

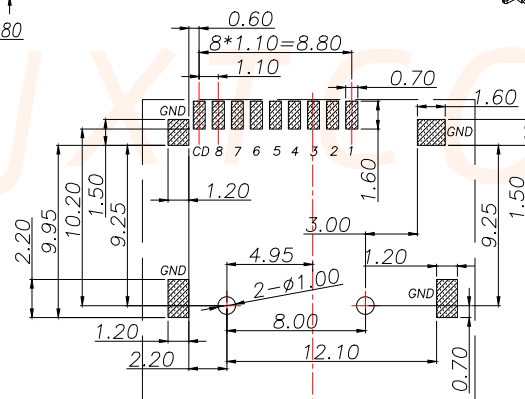
端子镀半金雾锡



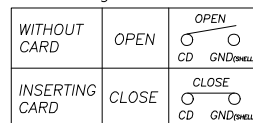
KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ± 0.05

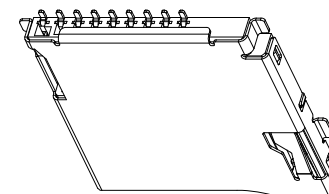


Circuit Diagram for Detect Switch

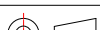


Specification:

1. **Electrical Characteristics:**
Contact Current Rating: 0.5 Amperes.
Dielectric Withstanding Voltage: AC500V r.m.s.
Insulation Resistance: 1000 MΩ Minimum.
Contact Resistance: 40 mΩ Maximum.
2. **Environmental:**
Operating Temperature: -25°C ~ +90°C.
3. **Environmental:**
Mating Cycles: 5,000 Insertions.
4. **Mechanical Characteristics:**
Card Push Insertion/Out Force: 0.2 ~ 1.40 kgf.
Contact Separation Force: 0.20 kgf Minimum.
5. **Material:**
Insulator: HI-Temp Plastic UL 94V-0 Rated.
Contact: Copper Alloy (t=0.15mm).
Shell: Stainless Steel (t=0.15mm).
Spring: SWP.
6. **Contact Plated:** Au 1u" Plated

TF CARD PIN DEFINE

PIN NO.	NAME	YTYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DATO	I/O/PP	DATE LINE(BITO)
8	DAT1	I/O/PP	DATE LINE(DIT1)

TOLERANCE		 深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
.X±0.35	.X°±3°	PART NO. TF-PUSH-P9	TITLE: MICRO SD CARD PUSH PUSH SMT 不鍍金 外焊		
.XX±0.25	.XX°±2°				
.XXX±0.15					
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG		
MATERILA	— — —	CHED: Olivia		SCALE	SHEET
FINISH	— — —	APPD: Ava		N:A	1/2



深圳聚兴泰电子科技有限公司
Shenzhen Juxingtai Electronic Technology Co., L

PART NO.

TF-PUSH-P9

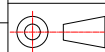
DESIGN: *Ethan*

DESIGN:	Ethan
CLIENT:	Olivia

CHED:	UIMA
APP:	...

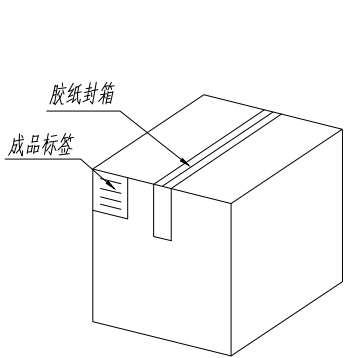
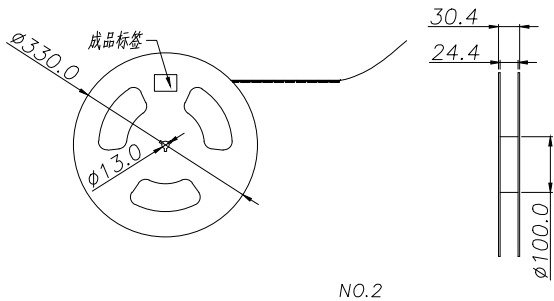
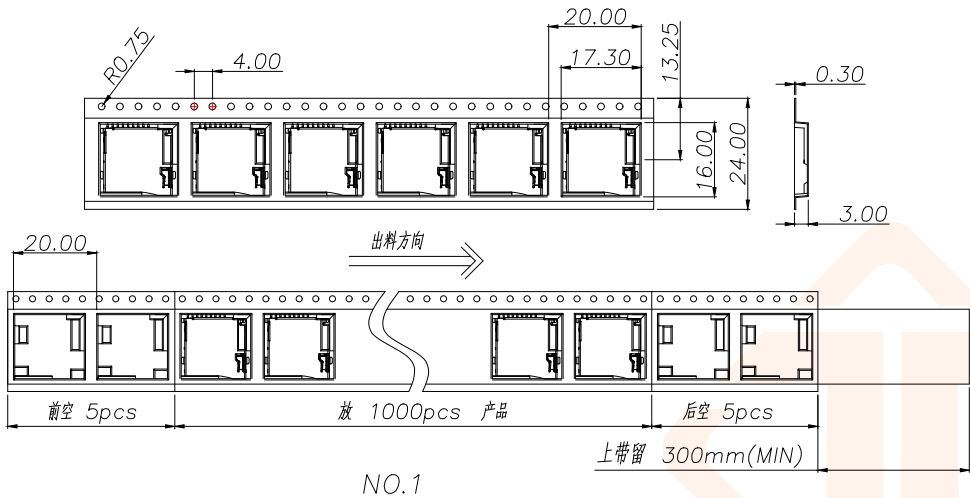
TITLE: MICRO SD CARD
PUSH PUSH SMT 不鍍金 外焊

MANUFACTURE DWG



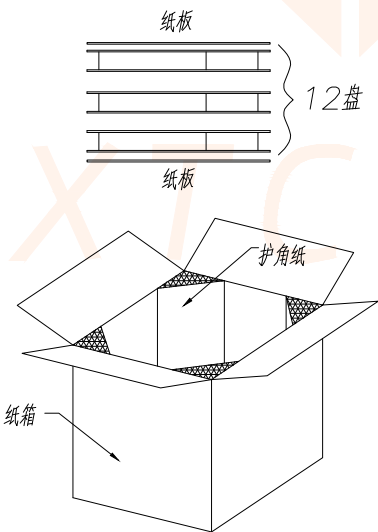
SCALE	SHEET
N:A	1/2

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



纸箱规格:340*340*385

NO.4



NO.3

1. 材质要求:

- 1.1 纸箱的材质为K=K;外形尺寸为34*34*38.5;
- 1.2 卷盘的材质为PS,卷盘的外形尺寸为 $\phi 330*30.4$;
- 1.3 卷带的材质为PS,卷带的外形尺寸为20200*24.00*3.0mm;

2. 包装方式:

- 2.1 将卷带放入包装机后,前空5PCS,后放产品1000PCS,再后空5PCS;上带留300MM长度.
- 2.2 将包装好的产品从包装机上取下并包装好,贴上内盘标签;
- 2.3 把累叠好的12盘叠放入纸箱中共计12Kset,上下放纸板,纸箱四个角塞护角纸;
- 2.4 把包装好的成品打包封箱,并在纸箱外贴上标签

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
.X $\pm$ 0.35	.X* $\pm$ 3°	PART NO. TF-PUSH-P9	TITLE: MICRO SD CARD PUSH PUSH SMT 不镀金 外焊		
.XX $\pm$ 0.25	.XX* $\pm$ 2°				
.XXX $\pm$ 0.15					
UNITS	mm	DESIGN:	Ethan	MANUFACTURE DWG	
MATERILA	---	CHED:	Olvia		
FINISH	---	APPD:	Ava		SCALE N:A
					SHEET 2/2